TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

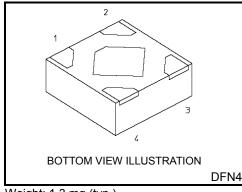
TCR3UM series

Ultra low quiescent current, Fast Load Transient 300 mA CMOS Low Drop-Out Regulator in ultra small package

The TCR3UM series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring ultra low quiescent bias current and low dropout voltage.

These voltage regulators are available in fixed output voltages between 0.8 V and 5.0 V and capable of driving up to 300 mA. They feature Over-current protection, Thermal Shutdown function and Auto-discharge.

The TCR3UM series is offered in the ultra small plastic mold package DFN4 (1.0 mm x 1.0 mm; t 0.60 mm (max)) and has a low dropout voltage of 196 mV (3.3 V output, IOUT = 300 mA). As small ceramic input and output capacitors 1 μF can be used with the TCR3UM series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones, IoT equipment and wearable devices.



Weight: 1.3 mg (typ.)

Applications

Power IC developed for portable applications, IoT equipment and wearable devices

Features

- Ultra small package DFN4 (1.0 mm x 1.0 mm; t 0.60 mm (max)).
- Low quiescent bias current (IB = 0.34 μA (typ.) at I_{OUT} = 0 mA, output voltage up to 1.5 V)
- High Ripple rejection ratio 70 dB at 0.8 V-output
- Fast Load transient response -51/+36 mV at 0.8 V-output, IOUT = 1 mA ⇔ 50 mA
- · Low Drop-Out voltage
 - VIN-VOUT = 196 mV (typ.) at 3.3 V-output, IOUT = 300 mA
- Wide range output voltage line up (Vout = 0.8 to 5.0 V)
- High Vout accuracy ± 1.0 % (1.8 V ≤ Vout)
- · Overcurrent protection
- Thermal Shutdown function
- Auto-discharge
- · Inrush current protection circuit
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used (CIN = 1 μF, COUT = 1 μF)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	VIN	-0.3 to 6.0	V
Control voltage	Vст	-0.3 to $V_{IN} + 0.3 \le 6.0$	V
Output voltage	Vout	-0.3 to V _{IN} + 0.3 ≤ 6.0	V
Power dissipation	PD	420 (Note1)	mW
Junction temperature	Tj	150	°C
Storage temperature range	T _{stg}	−55 to 150	°C

Note:

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board

Glass epoxy (FR4) board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole: diameter 0.5 mm x 24

Operating Ranges

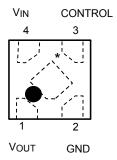
Characteristics	Symbol		Rating		Unit
Input voltage	VIN		1.5 to 5.5	(Note 2)	V
Control voltage	VcT		0 to VIN		V
Output voltage	Vout		0.8 to 5.0		V
Output current	lout	DC	300	(Note 3)	mA
Operation Temperature	Topr		-40 to 85		°C
Output Capacitance	Соит	≥ 1.0 µF			_
Input Capacitance	CIN	≥ 1.0 µF			_

Note 2: IOUT = 1 mA.

Please refer to Dropout Voltage (Page 7) and use it within Absolute Maximum Ratings Junction temperature and Operation Temperature Ranges.

Note 3: Do not operate at or near the maximum ratings of operating ranges for extended periods of time. Exposure to such conditions may adversely impact product reliability and results in failures not covered by warranty.

Pin Assignment (top view)



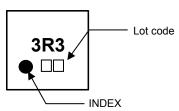
*Center electrode should be connected to GND or Open

List of Products Number, Output voltage and Marking

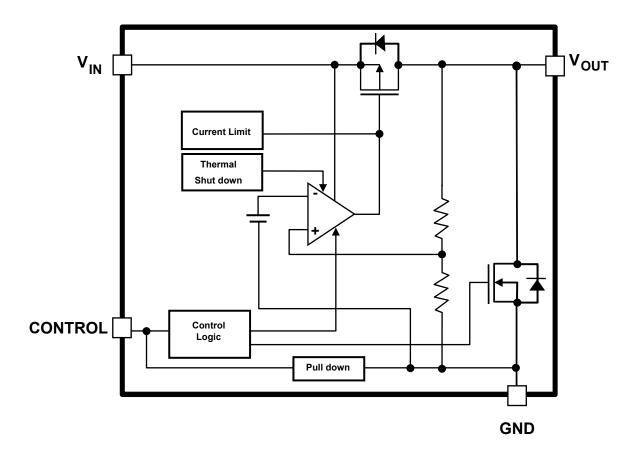
Product No.	Product No. Output voltage(V)		Marking	
TCR3UM08A	0.8		0R8	
TCR3UM085A	0.85		0RA	
TCR3UM09A	0.9		0R9	
TCR3UM095A	0.95		0RB	
TCR3UM10A	1.0		1R0	
TCR3UM105A	1.05		1RC	
TCR3UM11A	1.1		1R1	
TCR3UM115A	1.15		1RE	
TCR3UM12A	1.2		1R2	
TCR3UM13A	1.3		1R3	
TCR3UM135A	1.35		1RF	
TCR3UM14A	1.4		1R4	
TCR3UM15A	1.5		1R5	
TCR3UM16A	1.6		1R6	
TCR3UM175A	1.75		1RG	
TCR3UM18A	1.8		1R8	
TCR3UM1825A	1.825		1RH	
TCR3UM185A	1.85	V	1RJ	
TCR3UM19A	1.9	Yes	1R9	
TCR3UM25A	2.5		2R5	
TCR3UM26A	2.6		2R6	
TCR3UM27A	2.7		2R7	
TCR3UM28A	2.8		2R8	
TCR3UM285A	2.85		2RK	
TCR3UM29A	2.9		2R9	
TCR3UM2925A	2.925		2RL	
TCR3UM30A	3.0		3R0	
TCR3UM31A	3.1		3R1	
TCR3UM32A	3.2		3R2	
TCR3UM33A	3.3		3R3	
TCR3UM35A	3.5		3R5	
TCR3UM36A	3.6		3R6	
TCR3UM41A	4.1		4R1	
TCR3UM42A	4.2		4R2	
TCR3UM45A	4.5		4R5	
TCR3UM50A	5.0		5R0	

Top Marking (top view)

Example: TCR3UM33A (3.3 V output)



Block Diagram



Electrical Characteristics

(Unless otherwise specified,

VIN = VOUT+1 V (VOUT>1.5V), VIN=2.5V (VOUT \leq 1.5V), IOUT = 50 mA, CIN = COUT = 1 μ F)

Characteristics Symbol		Test Condition		T _j = 25°C			T _j = -40 to 85°C (Note 9)		Unit
				Min	Тур.	Max	Min	Max	
Output valtage	Vour	I _{OUT} = 50 mA	V _{OUT} < 1.8 V	-18	_	+18	_	_	mV
Output voltage	Vout	(Note 4)	1.8V ≤ V _{OUT}	-1.0	_	+1.0	_	_	%
Input voltage	VIN	IOUT = 1 mA		1.5	_	5.5	1.5	5.5	V
Line regulation	Reg·line	I _{OUT} = 1 mA	(Note 5)	-	1	15	_	_	mV
Load regulation	Reg·load	1 mA ≤ I _{OUT} ≤ 300	mA (Note 6)	_	17	30	_	_	mV
	I _B (ON1)	I _{OUT} = 0 mA, V _{OU}	T ≤ 1.5V (Note 7)	_	0.34	_	_	0.58	μA
Quiescent current	I _B (ON2)	I _{OUT} = 0 mA, 1.75 V ≤ V _{OUT} ≤ 5	V (Note 7)	_	0.38	_	_	0.68	μA
Chand has assument	I _{B (OFF1)}	$V_{CT} = 0 \text{ V}, V_{IN} = 2.5$	5 V	1	0.03	_	_	0.16	μA
Stand-by current	I _{B (OFF2)}	$V_{CT} = 0 \text{ V}, V_{IN} = 5.5$	5 V	-	0.03	_	_	0.20	μΑ
Control pull down current	I _{CT}	_		_	0.1	_	_	_	μA
Deep out valtage		200 m A	V _{OUT} = 1.8 V	_	336	_	_	457	mV
Drop-out voltage V _{DO}	I _{OUT} = 300 mA	V _{OUT} = 3.3 V	_	196	_	_	273	mV	
Output current limit	I _{CL}	V _{OUT} = V _{OUT} (NOM)*90% (Note 9)		_	545	_	400	_	mA
Output noise voltage	V _{NO}	I _{OUT} = 10 mA, 10 Hz ≤ f ≤ 100 kHz, Ta = 25°C (Note 6)		_	41	_	_	_	μV _{rms}
Ripple rejection ratio	R.R.	I_{OUT} = 10 mA, f = 1 kHz, V_{Ripple} = 200 m V_{p-p} , Ta = 25°C (Note 6)		_	70	_	_	_	dB
Load transient response	41	I _{OUT} =1mA → 50m	I _{OUT} =1mA → 50mA (Note 8)		-51	_	_	_	mV
Load transient response	⊿Vouτ	I _{OUT} =50mA → 1mA (Note 8)		_	+36	_	_	_	mV
Temperature coefficient	T _{CVO}	-40°C ≤ T _{opr} ≤ 85°C			75	_	_	_	ppm/°C
Control voltage (ON)	V _{CT (ON)}	_		1.0	_	5.5	1.0	5.5	V
Control voltage (OFF)	V _{CT (OFF)}	_		0	_	0.4	0	0.4	V
Discharge on resistance	RsD	_			7	_	_	_	Ω
Thermal shutdown temperature	T _{SD}	(Note 9) (Note 10)			158	_	_	_	°C
Thermal shutdown hysteresis	T _{SDH}	(Note 9) (Note 10)		_	28	_	_	_	°C

Note 4: stable state with fixed IOUT condition Note 5: $VOUT \le 1.5 \text{ V}, 2.5 \text{ V} \le VIN \le 5.5 \text{ V}$

 $1.75~\textrm{V} \leq \textrm{Vout} \leq 4.2~\textrm{V},~\textrm{Vout} + 1~\textrm{V} \leq \textrm{Vin} \leq 5.5~\textrm{V}$

Vout = 4.5 V, Vout = 5.0 V, not applicable

Note 6: Vout = 0.8V

Note 7: except Control pull down current (ICT)

Note 8: $V_{OUT} = 0.8 \text{ V}, V_{IN} = 3.3 \text{ V}$

Note 9: This parameter is warranted by design

Note 10: $V_{OUT} = 0.8 \text{ V}$, $V_{IN} = 2.5 \text{ V}$

Drop-out voltage

(IOUT = 300 mA, $C_{IN} = C_{OUT} = 1 \mu F$)

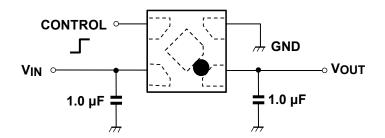
Output voltages	Symbol	Min	Typ. T _j = 25°C	Max (Note 11)	Unit
0.8 V ≤ V _{OUT} < 0.9 V		_	1020	1257	
0.9 V ≤ V _{OUT} < 1.0 V		_	933	1157	
1.0 V ≤ V _{OUT} < 1.1 V		_	848	1057	
1.1 V ≤ V _{OUT} < 1.2 V		_	760	957	
1.2 V ≤ V _{OUT} < 1.3 V		_	667	857	
1.3 V ≤ V _{OUT} < 1.5 V		_	580	757	
1.5 V ≤ V _{OUT} < 1.6 V		_	462	617	
1.6 V ≤ V _{OUT} < 1.8 V	VIN-VOUT	_	420	537	mV
1.8 V ≤ V _{OUT} < 2.0 V		_	336	457	
2.0 V ≤ V _{OUT} < 2.5 V		_	292	405	
2.5 V ≤ V _{OUT} < 3.0 V		_	216	327	
3.0 V ≤ V _{OUT} < 3.6 V		_	196	273	
3.6 V ≤ V _{OUT} < 4.5 V		_	174	232	
4.5 V ≤ V _{OUT} ≤ 5.0 V		_	149	210	

Note 11: $T_j = -40$ to 85 °C. This parameter is warranted by design

2018-08-20

Application Note

1. Recommended Application Circuit



CONTROL voltage	Output voltage
HIGH	ON
LOW	OFF
OPEN	OFF

The figure above shows the recommended configuration for using a Low-Dropout regulator. Insert a capacitor at V_{OUT} and V_{IN} pins for stable input/output operation. (Ceramic capacitors can be used).

2. Power Dissipation

Board-mounted power dissipation ratings for TCR3UM series are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

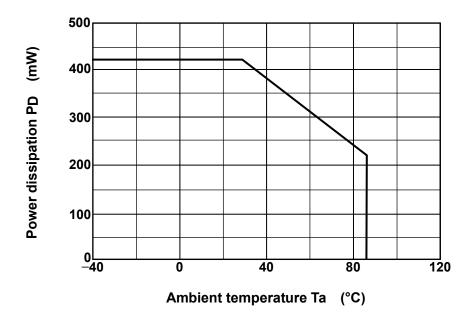
[The Board Condition]

Board material: Glass epoxy (FR4)

Board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm

Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole hall: diameter 0.5 mm x 24



8

2018-08-20

Attention in Use

Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommend the ESR of ceramic capacitor is under 10 Ω . For stable operation, we recommend over 1 μ F.

Mounting

The long distance between IC and input output capacitor might affect phase compensation by impedance in wire and inductor. For stable power supply, input output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of ambient temperature, input voltage, and output current etc., we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 %.

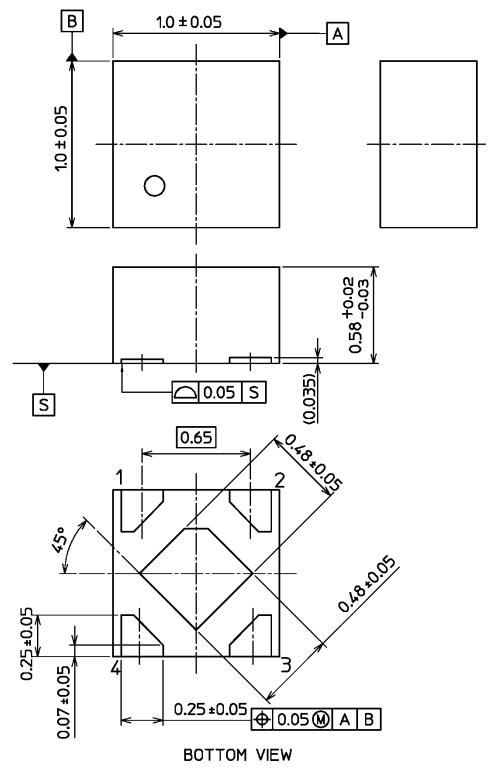
Over current Protection and Thermal shut down function.

Over current protection and Thermal shut down function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might break down.

When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.

Package Information

DFN4 Unit: mm



0.04 mm (typ.) unevenness exists along the edges of the back electrode to increase shear after soldering.

Weight: 1.3 mg (typ.)

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11

2018-08-20